

Features

- 2 to 6 V operating voltage
- Low power DC dissipation: 1 μ A max. at 25 °C
- High speed $t_{PD} = 8$ ns typ. at 25 °C
- Symmetrical outputs characteristics
- High noise immunity: 28% of min. V_{CC}
- Hermetic packages
- Rad-hard 50 krad (Si)
- SEL immune up to 110 MeV/mg/cm²
- ESCC qualified
- Same die and electrical specification for engineering and flight models
- The complete specification of each type is available from the ESCC web site: <https://escies.org> using its ESCC part number. STMicroelectronics® guarantees full compliance of qualified parts with these ESCC specifications.

Description

The M54HCxxx and M54HCTxxx series are composed of 90 types of high speed CMOS functions specifically designed to meet the radiation requirements of the aerospace industry. It includes a large set of gates, flip-flops, multiplexers, counters, bus interface and several other functions. The radiation hardness, the single event latch-up (SEL) immunity and the housing in hermetic packages of all types of both series make them ideally suited for use in the most difficult environmental conditions.

Contents

- 1 M54HC and M54HCT families overview 3**
- 2 Input and output equivalent circuit diagram 9**
- 3 Maximum rating 10**
 - 3.1 Absolute maximum ratings 10
 - 3.1.1 M54HC series 10
 - 3.1.2 M54HCT series 10
 - 3.2 Recommended operating conditions 11
 - 3.2.1 M54HC series 11
 - 3.2.2 M54HCT series 11
- 4 Radiation data 12**
- 5 Package information 13**
- 6 Order codes 21**
- 7 Other information 28**
 - 7.1 Date code 28
 - 7.2 Documentation 28
- 8 Revision history 29**



1 M54HC and M54HCT families overview

Table 1. Device summary

Part number	Description	Radiation level	Agency qualification	EPPL	ESCC specification	Package	V _{CC}		V _{IN} range	Other features	Temp. range
							Min.	Max.			
M54HC00	Rad-hard quad 2-input NAND gate	50 krad (Si)	ESCC	Y	9201/105	Flat-14 - DIL-14	2.0	6.0	0 to V _{CC}		-55 °C to 125 °C
M54HC02	Rad-hard quad 2-input NOR gate			Y	9201/113	Flat-14 - DIL-14	2.0	6.0			
M54HC03	Rad-hard quad 2-input NAND open drain			Y	9201/114	Flat-14 - DIL-14	2.0	6.0			
M54HC04	Rad-hard hex inverter			Y	9401/033	Flat-14 - DIL-14	2.0	6.0			
M54HC08	Rad-hard quad 2-input AND gate			Y	9201/106	Flat-14 - DIL-14	2.0	6.0			
M54HC10	Rad-hard triple 3-input NAND gate			Y	9201/107	Flat-14 - DIL-14	2.0	6.0			
M54HC11	Rad-hard triple 3-input AND gate			Y	9201/117	Flat-14 - DIL-14	2.0	6.0			
M54HC14	Rad-hard hex Schmitt inverter			Y	9409/007	Flat-14 - DIL-14	2.0	6.0			
M54HC20	Rad-hard dual 4-input NAND gate			Y	9201/118	Flat-14 - DIL-14	2.0	6.0			
M54HC21	Rad-hard dual 4-input AND gate			Y	9201/108	Flat-14 - DIL-14	2.0	6.0			
M54HC27	Rad-hard triple 3-input NOR gate			Y	9201/109	Flat-14 - DIL-14	2.0	6.0			
M54HC30	Rad-hard 8-input NAND gate			-	9201/110	Flat-14 - DIL-14	2.0	6.0			
M54HC32	Rad-hard quad 2-input OR gate			Y	9201/111	Flat-14 - DIL-14	2.0	6.0			



Table 1. Device summary (continued)

Part number	Description	Radiation level	Agency qualification	EPPL	ESCC specification	Package	V _{CC}		V _{IN} range	Other features	Temp. range
							Min.	Max.			
M54HC73	Rad-hard dual J-K flip-flop with clear	50 krad (Si)	ESCC	-	9203/071	Flat-14 - DIL-14	2.0	6.0	0 to V _{CC}	Negative edge	-55 °C to 125 °C
M54HC74	Rad-hard dual D-type flip-flop with preset and clear			Y	9203/050	Flat-14 - DIL-14	2.0	6.0		Positive edge	
M54HC74	Rad-hard dual D-type flip-flop with preset and clear			Y	9203/070	Flat-14 - DIL-14	4.5	5.5		Positive edge TTL compatible	
M54HC75	Rad-hard 4-bit D-type latch			-	9203/065	Flat-16 - DIL-16	2.0	6.0			
M54HC85	Rad-hard 4-bit magnitude comparator			Y	9209/004	Flat-16 - DIL-16	2.0	6.0			
M54HC86	Rad-hard quad exclusive OR gate			Y	9201/119	Flat-14 - DIL-14	2.0	6.0		Pinout 1	
M54HC109	Rad-hard dual J-K flip-flop with preset and clear			Y	9306/048	Flat-16 - DIL-16	2.0	6.0		Positive edge	
M54HC123	Rad-hard dual retrigger. monostable multivibrator with clear			-	9207/006	Flat-16 - DIL-16	2.0	6.0			
M54HC125	Rad-hard quad bus buffer 3-state			Y	9401/039	Flat-14	2.0	6.0		Inverted enables	
M54HC132	Rad-hard quad 2-input Schmitt NAND gate			Y	9201/120	Flat-14 - DIL-14	2.0	6.0			
M54HC137	Rad-hard 3-to-8 line decoder latch inverter			-	9205/013	Flat-16 - DIL-16	2.0	6.0			
M54HC138	Rad-hard 3-to-8 line decoder inverter			Y	9408/046	Flat-16 - DIL-16	2.0	6.0			
M54HC139	Rad-hard dual 2-to-4 line decoder/demultiplexer			Y	9205/017	Flat-16 - DIL-16	2.0	6.0			
M54HC148	Rad-hard 8-to-3 line priority encoder			-	9410/017	Flat-16 - DIL-16	2.0	6.0			



Table 1. Device summary (continued)

Part number	Description	Radiation level	Agency qualification	EPPL	ESCC specification	Package	V _{CC}		V _{IN} range	Other features	Temp. range
							Min.	Max.			
M54HC151	Rad-hard 8-channel multiplexer	50 krad (SI)	ESCC	Y	9408/054	Flat-16 - DIL-16	2.0	6.0	0 to V _{CC}		-55 °C to 125 °C
M54HC153	Rad-hard dual 4-channel multiplexer			-	9408/038	Flat-16 - DIL-16	2.0	6.0			
M54HC154	Rad-hard 4-to-16 line decoder/demultiplexer			Y	9205/023	Flat-24 - DIL-24	2.0	6.0			
M54HC157	Rad-hard quad 2-channel multiplexer			Y	9408/057	Flat-16 - DIL-16	2.0	6.0			
M54HC158	Rad-hard quad 2-channel multiplexer Inverter			Y	9408/059	Flat-16 - DIL-16	2.0	6.0			
M54HC160	Rad-hard synchronous decade counter with async. clear			-	9204/062	DIL-16	2.0	6.0			
M54HC161	Rad-hard synchronous binary counter with async. clear			Y	9204/059	Flat-16 - DIL-16	2.0	6.0			
M54HC164	Rad-hard 8-bit SIPO shift register			Y	9306/041	Flat-14 - DIL-14	2.0	6.0			
M54HC165	Rad-hard 8-bit PISO shift register			Y	9306/042	Flat-16 - DIL-16	2.0	6.0			
M54HC166	Rad-hard 8-bit PISO shift register with clear			Y	9306/043	Flat-16 - DIL-16	2.0	6.0			
M54HC174	Rad-hard hex D-type flip-flop with clear			Y	9306/052	Flat-16 - DIL-16	2.0	6.0			
M54HC175	Rad-hard quad D-type flip-flop with clear			Y	9203/052	Flat-16 - DIL-16	2.0	6.0			
M54HC191	Rad-hard 4-bit synchronous binary up/down counter			Y	9204/066	Flat-16 - DIL-16	2.0	6.0			
M54HC193	Rad-hard synchronous up/down binary counter			Y	9204/065	Flat-16 - DIL-16	2.0	6.0			

Table 1. Device summary (continued)

Part number	Description	Radiation level	Agency qualification	EPPL	ESCC specification	Package	V _{CC}		V _{IN} range	Other features	Temp. range
							Min.	Max.			
M54HC194	Rad-hard 4-bit PIPO shift register	50 krad (Si)	ESCC	-	9306/047	Flat-16 - DIL-16	2.0	6.0	0 to V _{CC}	4 shift modes	-55 °C to 125 °C
M54HC237	Rad-hard 3-to-8 line decoder latch			Y	9205/021	Flat-16 - DIL-16	2.0	6.0			
M54HC240	Rad-hard octal bus buffer 3-state inverter			Y	9401/034	Flat-20 - DIL-20	2.0	6.0		Independent enables TTL compatible	
M54HCT240	Rad-hard octal bus buffer 3-state inverter			Y	9401/045	Flat-20 - DIL-20	4.5	5.5			
M54HC244	Rad-hard octal bus buffer 3-state			Y	9401/048	Flat-20 - DIL-20	2.0	6.0		Inverted enables	
M54HCT244	Rad-hard octal bus buffer 3-state			Y	9402/009	Flat-20 - DIL-20	4.5	5.5		Inverted enables TTL compatible	
M54HC245	Rad-hard octal bus transceiver 3-state			Y	9405/013	Flat-20 - DIL-20	2.0	6.0			
M54HCT245	Rad-hard octal bus transceiver 3-state			Y	9405/014	Flat-20 - DIL-20	4.5	5.5		TTL compatible	
M54HC251	Rad-hard 8-channel multiplexer 3-state			-	9408/048	Flat-16 - DIL-16	2.0	6.0			
M54HC257	Rad-hard quad 2-channel multiplexer 3-state			Y	9408/047	Flat-16	2.0	6.0			
M54HC259	Rad-hard 8-bit addressable latch			-	9203/073	Flat-16 - DIL-16	2.0	6.0			
M54HC273	Rad-hard octal d-type flip-flop with clear			Y	9203/053	Flat-20 - DIL-20	2.0	6.0			
M54HC283	Rad-hard 4-bit binary full adder			Y	9202/075	Flat-16 - DIL-16	2.0	6.0			



Table 1. Device summary (continued)

Part number	Description	Radiation level	Agency qualification	EPPL	ESCC specification	Package	V _{CC}		V _{IN} range	Other features	Temp. range
							Min.	Max.			
M54HC367	Rad-hard hex bus buffer 3-state	50 krad (Si)	ESCC	-	9401/044	Flat-16 - DIL-16	2.0	6.0	0 to V _{CC}	Independent enables	-55 °C to 125 °C
M54HC373	Rad-hard octal D-type latch 3-state			Y	9203/059	Flat-20 - DIL-20	2.0	6.0			
M54HCT373	Rad-hard octal D-type latch 3-state			Y	9203/064	Flat-20 - DIL-20	4.5	5.5		TTL compatible	
M54HC374	Rad-hard octal D-type flip-flop 3-state			Y	9203/060	Flat-20 - DIL-20	2.0	6.0			
M54HC393	Rad-hard dual binary counter			-	9204/074	Flat-14 - DIL-14	2.0	6.0			
M54HC540	Rad-hard octal bus buffer 3-state inverter			Y	9401/049	Flat-20 - DIL-20	2.0	6.0			
M54HC541	Rad-hard octal bus buffer 3-state			Y	9401/047	Flat-20 - DIL-20	2.0	6.0		Non inverted enables	
M54HC573	Rad-hard octal D-type latch 3-state			Y	9202/072	Flat-20 - DIL-20	2.0	6.0		Through chip pinout	
M54HC574	Rad-hard octal D-type flip-flop 3-state			Y	9203/054	Flat-20 - DIL-20	2.0	6.0		Through chip pinout	
M54HC590	Rad-hard 8 bit binary counter register 3-state			Y	9204/071	Flat-16 - DIL-16	2.0	6.0			
M54HC595	Rad-hard 8 bit shift register output latch 3-state			Y	9306/051	Flat-16 - DIL-16	2.0	6.0			
M54HC597	Rad-hard 8 bit latch/shift register			Y	9306/054	Flat-16 - DIL-16	2.0	6.0			
M54HC688	Rad-hard 8 bit equality comparator			Y	9209/005	Flat-20 - DIL-20	2.0	6.0			
M54HC4020	Rad-hard 14-stage binary counter			-	9204/070	Flat-16 - DIL-16	2.0	6.0			

Table 1. Device summary (continued)

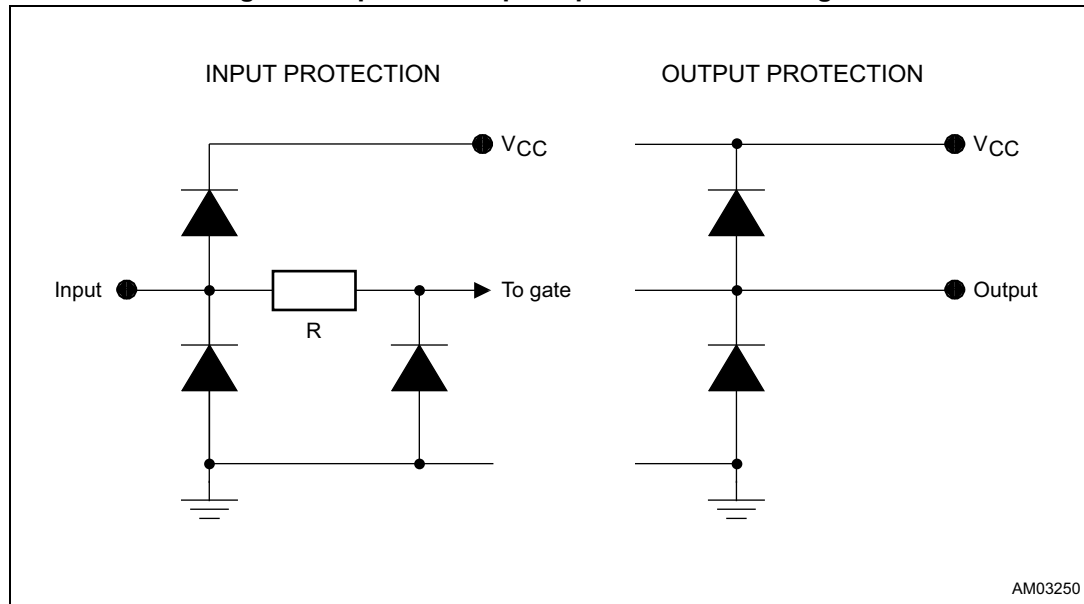
Part number	Description	Radiation level	Agency qualification	EPPL	ESCC specification	Package	V _{CC}		V _{IN} range	Other features	Temp. range
							Min.	Max.			
M54HC4040	Rad-hard 12-stage binary counter	50 krad (Si)	ESCC	Y	9204/069	Flat-16 - DIL-16	2.0	6.0	0 to V _{CC}		-55 °C to 125 °C
M54HC4049	Rad-hard hex buffer/converter inverter			Y	9401/037	Flat-16 - DIL-16	2.0	6.0			
M54HC4050	Rad-hard hex buffer/converter			Y	9401/038	Flat-16 - DIL-16	2.0	6.0			
M54HC4051	Rad-hard single 8-channel analog mux/demux			-	9408/064	Flat-16 - DIL-16	2.0	6.0			
M54HC4053	Rad-hard triple 2-channel analog mux/demux			-	9408/065	Flat-16 - DIL-16	2.0	6.0			
M54HC4060	Rad-hard 14-stage binary counter/oscillator			-	9204/076	Flat-16 - DIL-16	2.0	6.0			
M54HC4066	Rad-hard quad bilateral switch			-	9408/052	Flat-14 - DIL-14	2.0	6.0			
M54HC4078	Rad-hard 8-input NOR/OR gate			-	9201/123	Flat-14 - DIL-14	2.0	6.0			
M54HC4094	Rad-hard 8-bit SIPO shift register 3-state			-	9306/050	Flat-16 - DIL-16	2.0	6.0			
M54HC4514	Rad-hard 4-to-16 line decoder latch			-	9205/019	Flat-24 - DIL-24	2.0	6.0			

Note: Contact ST sales office for information about the specific conditions for other 54HC or 54HCT part numbers and for products in die form.



2 Input and output equivalent circuit diagram

Figure 1. Input and output equivalent circuit diagram



1. For the 54HC4049 input equivalent circuit, there is no diode connected to V_{CC} .

3 Maximum rating

3.1 Absolute maximum ratings

3.1.1 M54HC series

Table 2. Absolute maximum ratings - M54HC series

Symbol	Parameter	Value	Unit
V_{CC}	Supply voltage	-0.5 to +7	V
V_I	DC input voltage	-0.5 to $V_{CC} + 0.5$	V
V_O	DC output voltage	-0.5 to $V_{CC} + 0.5$	V
I_{IK}	DC input diode current	± 20	mA
I_{OK}	DC output diode current	± 20	mA
I_O	DC output current	± 25	mA
I_{CC} or I_{GND}	DC V_{CC} or ground current	± 50	mA
P_D	Power dissipation	300	mW
T_{stg}	Storage temperature	-65 to +150	$^{\circ}\text{C}$
T_L	Lead temperature (10 sec.)	265	$^{\circ}\text{C}$

Note: All voltage values are referred to V_{SS} pin voltage.

3.1.2 M54HCT series

Table 3. Absolute maximum ratings - M54HCT series^{(1), (2)}

Symbol	Parameter	Value	Unit
V_{CC}	Supply voltage	-0.5 to +7	V
V_I	DC input voltage	-0.5 to $V_{CC} + 0.5$	V
V_O	DC output voltage	-0.5 to $V_{CC} + 0.5$	V
I_{IK}	DC input diode current	± 20	mA
I_{OK}	DC output diode current	± 20	mA
I_O	DC output current	± 35	mA
I_{CC} or I_{GND}	DC V_{CC} or ground current	± 70	mA
P_D	Power dissipation	420	mW
T_{stg}	Storage temperature	-65 to +150	$^{\circ}\text{C}$
T_L	Lead temperature (10 sec.)	265	$^{\circ}\text{C}$

1. All voltage values are referred to V_{SS} pin voltage.

2. All values concern all bus buffer devices with 3-state outputs and the M54HC4049 device.

3.2 Recommended operating conditions

3.2.1 M54HC series

Table 4. Recommended operating conditions

Symbol	Parameter	Value	Unit
V_{CC}	Supply voltage	2 to 6	V
V_I	Input voltage	0 to V_{CC}	V
V_O	Output voltage	0 to V_{CC}	V
T_{op}	Operating temperature	-55 to 125	°C
t_r, t_f	Input rise and fall time ($V_{CC} = 4.5$ to 5.5 V)	0 to 500	ns

3.2.2 M54HCT series

Table 5. Recommended operating conditions

Symbol	Parameter	Value	Unit
V_{CC}	Supply voltage	4.5 to 5.5	V
V_I	Input voltage	0 to V_{CC}	V
V_O	Output voltage	0 to V_{CC}	V
T_{op}	Operating temperature	-55 to 125	°C
t_r, t_f	Input rise and fall time ($V_{CC} = 4.5$ to 5.5 V)	0 to 500	ns

4 Radiation data

Each wafer lot is qualified at 50 krad (Si) total dose as per ESCC 22900 specification at 210 rad/hour.

The HC/HCT series is characterized under heavy Ion on 4 functions representative of the whole series and qualified as per the results of this characterization.

Detailed results are provided in [Table 6](#):

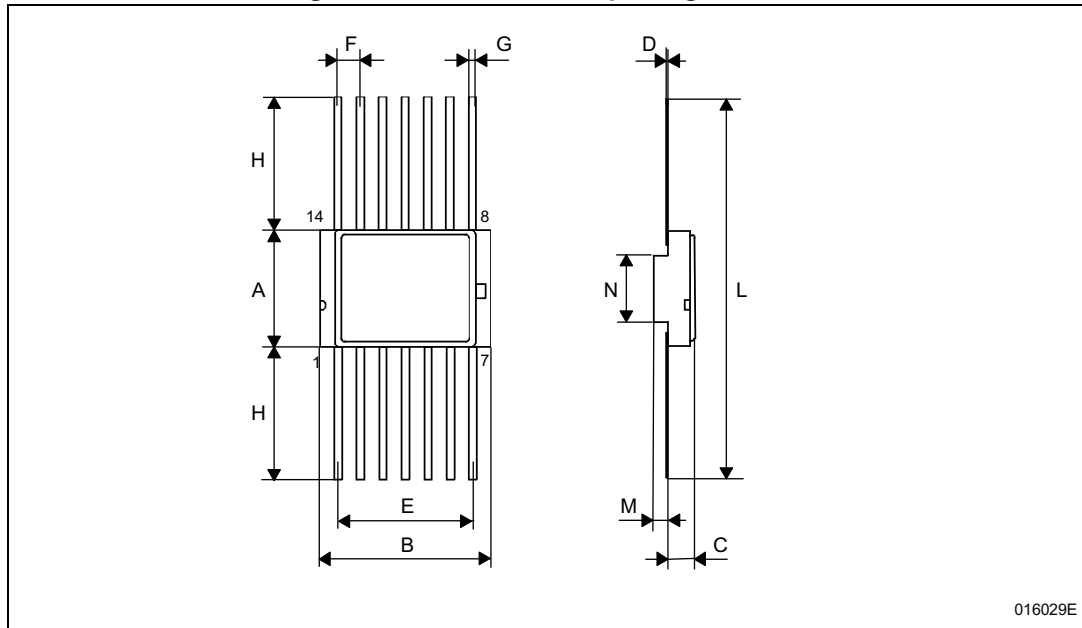
Table 6. Radiation data

Function	Result
Gate: 54HC08	SEL and SEU free for LET [111 MeV/mg/cm ²
Multiplexer 54HC157	SEL and SEU free for LET [111 MeV/mg/cm ²
Flip-flop 54HC273	SEL free for LET [111 MeV/mg/cm ²
	SEU: LET _{th} = 16 MeV/mg/cm ² , $\sigma_{sat} = 1.7 \times 10^{-4} \text{ cm}^2$
Counter 54HC4040	SEL free for LET [111 MeV/mg/cm ²
	SEU: LET _{th} = 34 MeV/mg/cm ² , $\sigma_{sat} = 4.2 \times 10^{-4} \text{ cm}^2$
Analog mux/demux 54HC4053	SEL free for LET [111 MeV/mg/cm ²
	SEU: LET _{th} = 7 MeV/mg/cm ² , $\sigma_{sat} = 2.4 \times 10^{-4} \text{ cm}^2$

5 Package information

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK® packages, depending on their level of environmental compliance. ECOPACK specifications, grade definitions and product status are available at: www.st.com. ECOPACK is an ST trademark.

Figure 2. Ceramic Flat-14 package outline



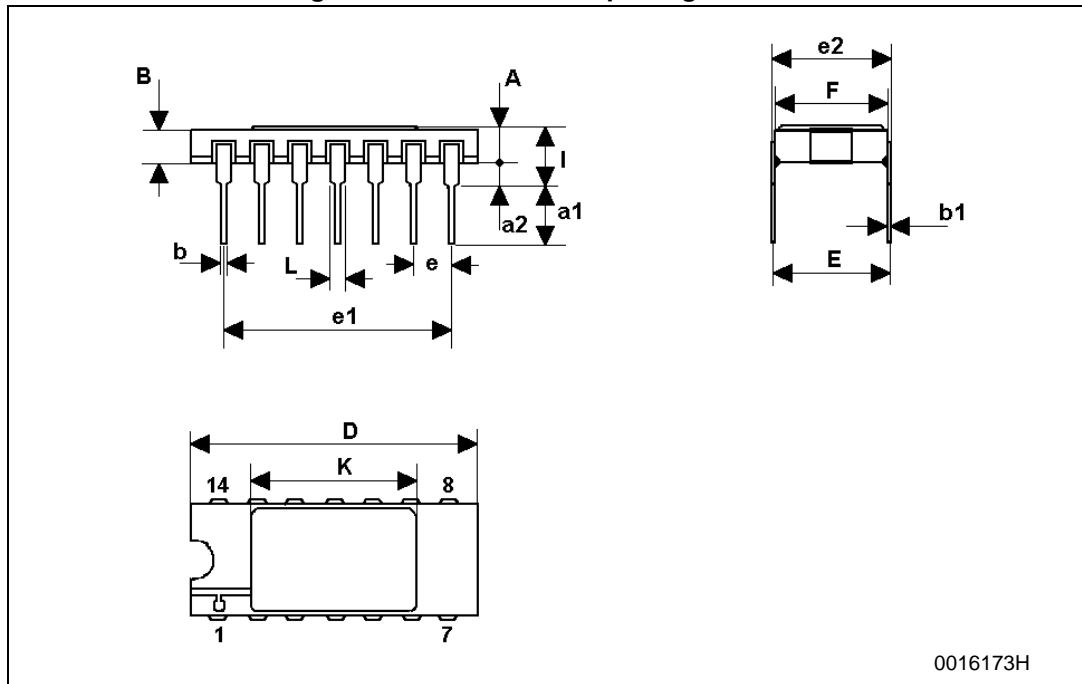
016029E

1. The upper metallic lid is not electrically connected to any pins, nor to the IC die inside the package. Connecting unused pins or the metallic lid to ground or to the power supply will not affect the electrical characteristics.

Table 7. Ceramic Flat-14 package mechanical data

Symbol	Dimensions (mm)		
	Min.	Typ.	Max.
A	6.75	6.91	7.06
B	9.76	9.95	10.14
C	1.49		1.95
D	0.10	0.127	0.15
E	7.50	7.62	7.75
F		1.27	
G	0.38	0.43	0.48
H		6.0	
L	18.75	en	22.0
M		0.38	
N		4.31	

Figure 3. Ceramic DIL-14 package outline

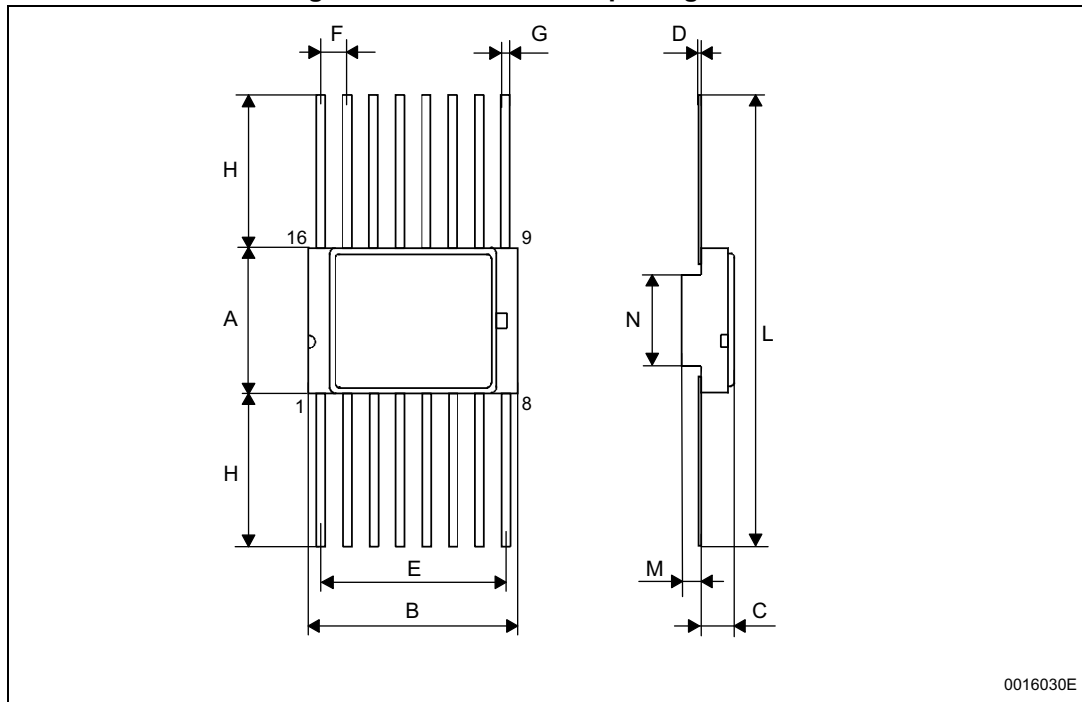


1. The upper metallic lid is not electrically connected to any pins, nor to the IC die inside the package. Connecting unused pins or the metallic lid to ground or to the power supply will not affect the electrical characteristics.

Table 8. Ceramic DIL-14 package mechanical data

Symbol	Dimensions (mm)		
	Min.	Typ.	Max.
A	2.1		2.54
a1	3.00		3.70
a2	0.63	0.88	1.14
B	1.82	2.03	2.39
b	0.40	0.45	0.50
b1	0.20	0.254	0.30
D	18.79	19.00	19.20
E	7.36	7.62	7.87
e		2.54	
e1	15.11	15.24	15.37
e2	7.62	7.87	8.12
F	7.11		7.75
I			3.70
K	10.90		12.1 n
L	1.14	1.27	1.5

Figure 4. Ceramic Flat-16 package outline

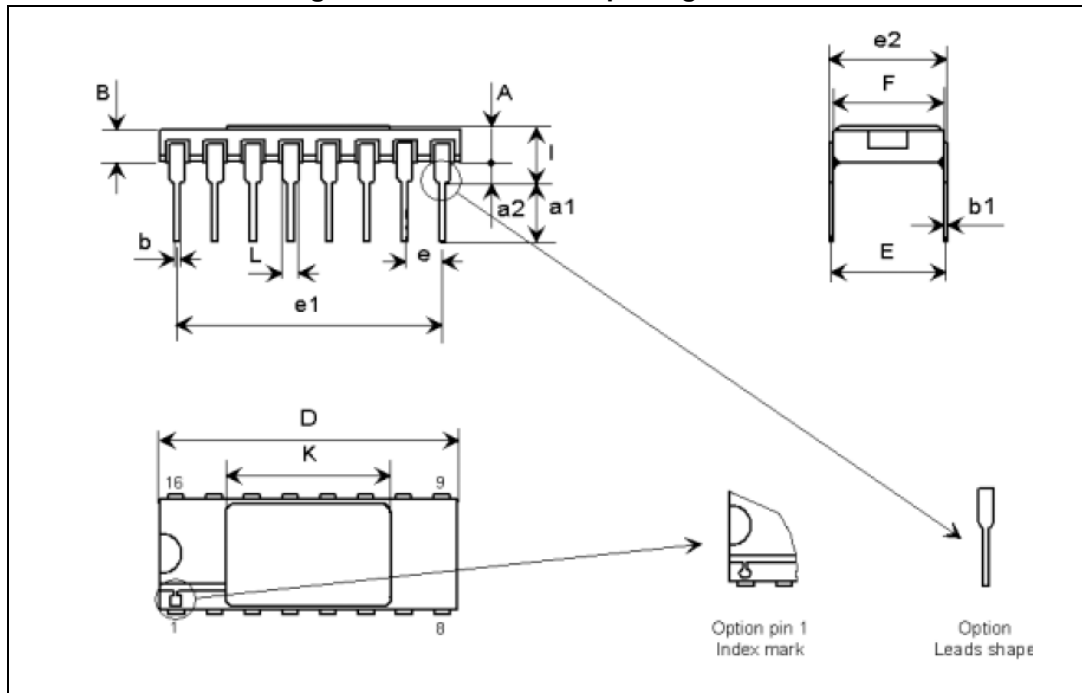


1. The upper metallic lid is not electrically connected to any pins, nor to the IC die inside the package. Connecting unused pins or the metallic lid to ground or to the power supply will not affect the electrical characteristics.

Table 9. Ceramic Flat-16 package mechanical data

Symbol	Dimensions (mm)		
	Min.	Typ.	Max.
A	6.75	6.91	7.06
B	9.76	9.94	10.14
C	1.49		1.95
D	0.102	0.127	0.152
E	8.76	8.89	9.01
F		1.27	
G	0.38	0.43	0.48
H	6.0		
L	18.75	20.38	22.0
M	0.33	0.38	0.43
N		4.31	

Figure 5. Ceramic DIL-16 package outline



1. The upper metallic lid is not electrically connected to any pins, nor to the IC die inside the package. Connecting unused pins or the metallic lid to ground or to the power supply will not affect the electrical characteristics.

Table 10. Ceramic DIL-16 package mechanical data

Symbol	Dimensions (mm)		
	Min.	Typ.	Max.
A	2.10		2.71
a1	3.00		3.70
a2	0.63	0.88	1.14
B	1.82		2.39
b	0.40	0.45	0.50
b1	0.20	0.254	0.30
D	20.06	20.32	20.58
E	7.36	7.62	7.87
e		2.54	
e1	17.65	17.78	17.90
e2	7.62	7.87	8.12
F	7.29	7.49	7.70
I			3.83
K	10.90		12.10
L	1.14		1.50

Figure 6. Ceramic Flat-20 package outline

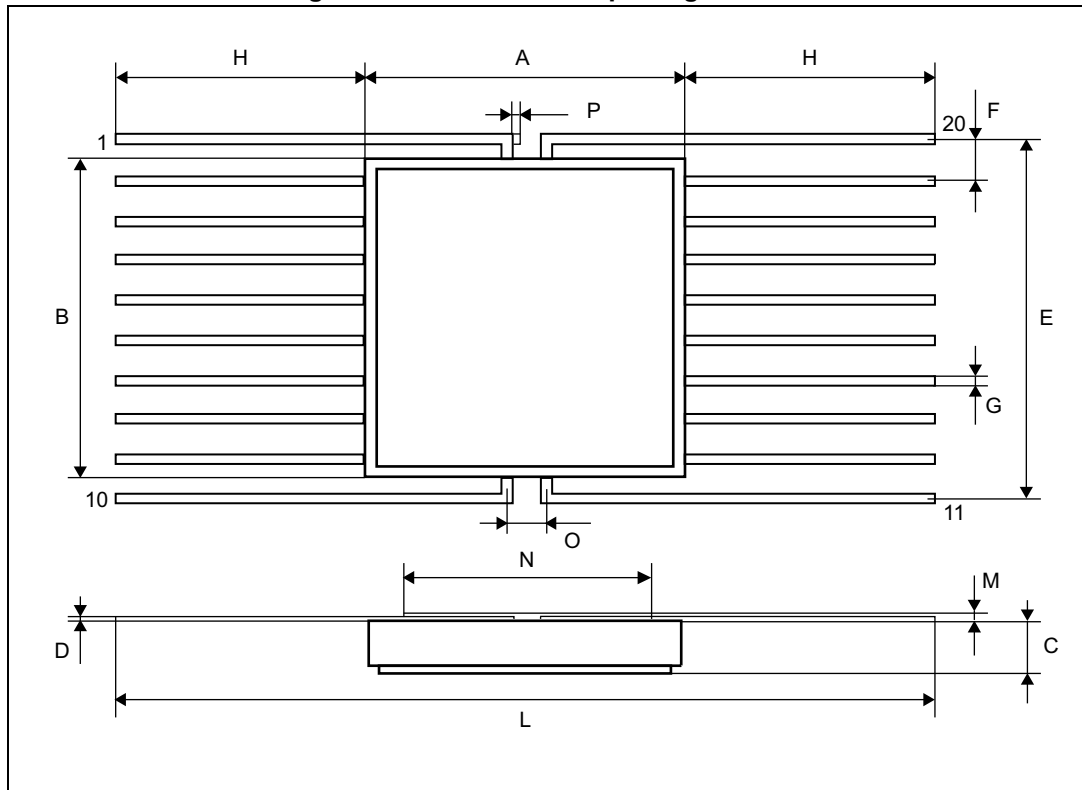


Table 11. Ceramic Flat-20 package mechanical data

Symbol	Dimensions (mm)		
	Min.	Typ.	Max.
A	9.98	10.16	10.34
B	9.98	10.16	10.34
C	1.45	1.61	1.78
D	0.10	0.127	0.18
E	11.30	11.43	11.56
F		1.27	
G	0.38	0.43	0.48
H	7.24		8.16
L	24.46		26.67
M	0.45	0.50	0.55
N		7.87	
O	1.14	1.27	1.40
P	0.10	0.18	0.25

Figure 7. Ceramic DIL-20 package outline

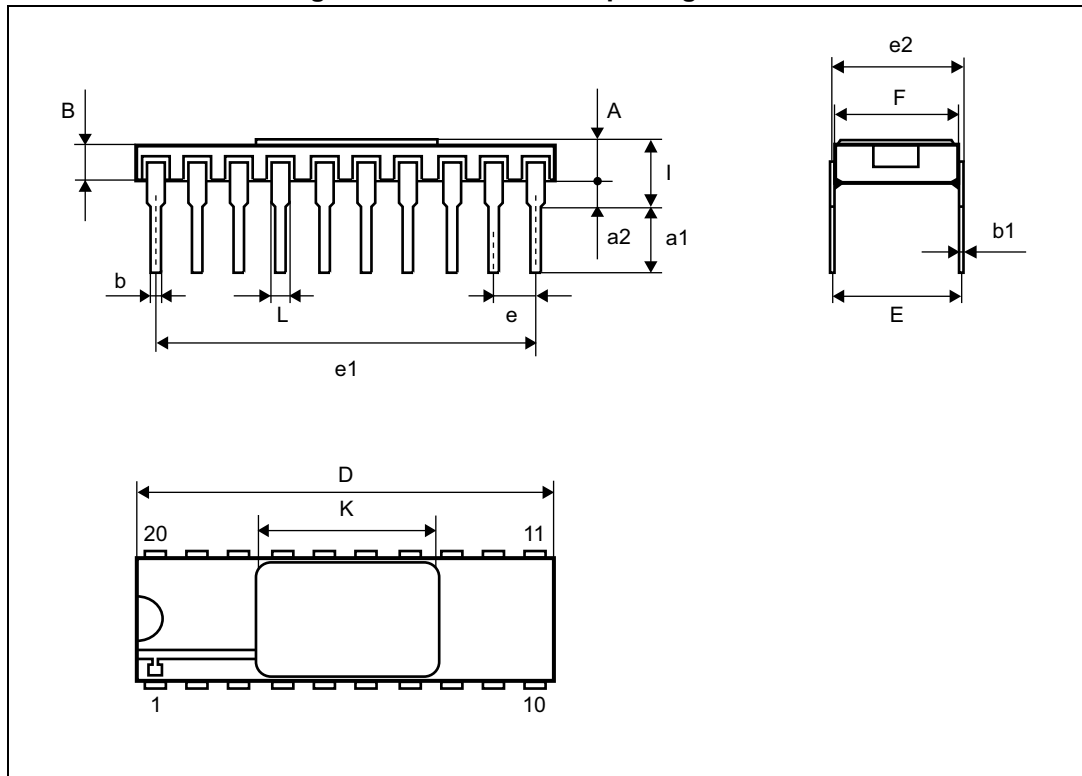
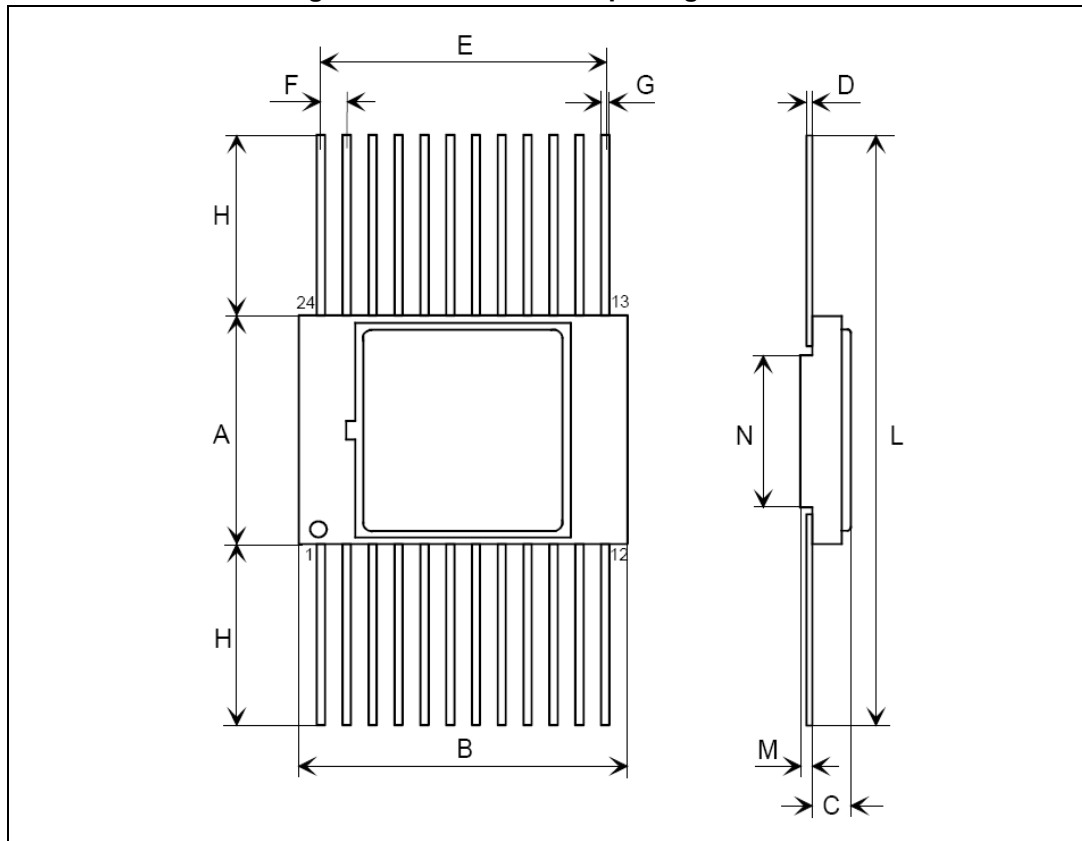


Table 12. Ceramic DIL-20 package mechanical data

Symbol	Dimensions (mm)		
	Min.	Typ.	Max.
A	2.10		2.72
a1	3.00		3.70
a2	0.63	0.88	1.14
B	1.93	2.03	2.23
b	0.40	0.45	0.50
b1	0.20	0.254	0.30
D	25.14	25.40	25.65
E	7.36	7.62	7.87
e		2.54	
e1	22.73	22.86	22.99
e2	7.62	7.87	8.12
F	7.29	7.49	7.62
I			3.86
K	11.30		11.56
L	1.14	1.27	1.40

Figure 8. Ceramic Flat-24 package outline

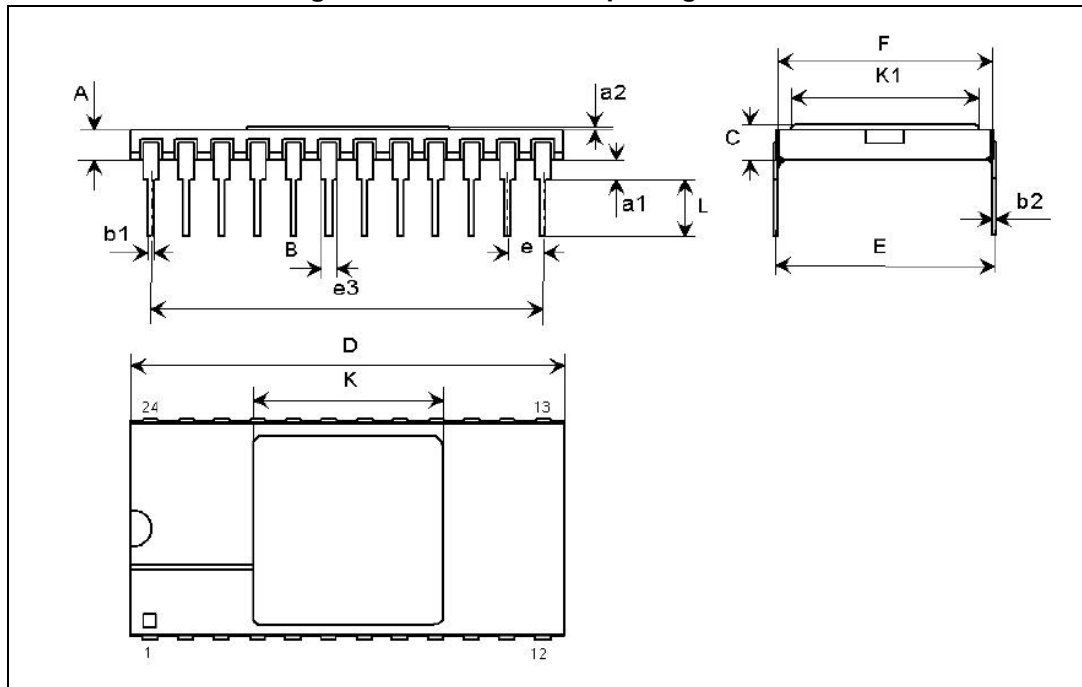


1. The upper metallic lid is not electrically connected to any pins, nor to the IC die inside the package. Connecting unused pins or the metallic lid to ground or to the power supply will not affect the electrical characteristics.

Table 13. Ceramic Flat-24 package mechanical data

Symbol	Dimensions (mm)		
	Min.	Typ.	Max.
A	10.70	11.00	11.30
B	15.30	15.49	15.70
C	1.45		1.90
D	0.23	0.254	0.30
E	13.84	13.97	14.10
F	1.22	1.27	1.32
G	0.45	0.508	0.55
H	7.25		8.25
L	25.00		28.00
M	0.45	0.508	0.55
N		7.01	

Figure 9. Ceramic DIL-24 package outline



1. The upper metallic lid is not electrically connected to any pins, nor to the IC die inside the package. Connecting unused pins or the metallic lid to ground or to the power supply will not affect the electrical characteristics.

Table 14. Ceramic DIL-24 package mechanical data

Symbol	Dimensions (mm)		
	Min.	Typ.	Max.
A	2.159	1.931	2.387
a1	1.270	1.016	1.524
a2	.307	.274	.340
B	1.270		
b1	0.457	0.407	0.507
b2	.254	0.229	0.304
C	2.466	2.205	2.727
D	30.48	30.17	30.78
E	15.24	14.98	15.49
e	2.540	2.410	2.670
e3	27.94	27.81	28.06
F	15.11	14.85	15.36
K	12.80	12.60	13.00
K1	12.80	12.60	13.00
L	3.300	3.000	3.800

6 Order codes

Table 15. Ordering information⁽¹⁾

Order codes	ESCC detailed specification	Quality level	Comment	Package	Lead finish	Marking ⁽²⁾	Mass (g)	EPPL	Packing
M54HC00K	9201/105/01F or 02F	ESCC flight	Specify ESCC variant number in PO	Flat-14	Gold or solder dip	920110501F or 02F	0.70	Y	Strip pack
M54HC00D	9201/105/03F or 04F	ESCC flight	Specify ESCC variant number in PO	DIL-14	Gold or solder dip	920110503F or 04F	2.20	-	Strip pack
M54HC02K	9201/113/01F or 02F	ESCC flight	Specify ESCC variant number in PO	Flat-14	Gold or solder dip	920111301F or 02F	0.70	Y	Strip pack
M54HC02D	9201/113/03F or 04F	ESCC flight	Specify ESCC variant number in PO	DIL-14	Gold or solder dip	920111303F or 04F	2.20	-	Strip pack
M54HC03K	9201/114/01F or 02F	ESCC flight	Specify ESCC variant number in PO	Flat-14	Gold or solder dip	920111401F or 02F	0.70	Y	Strip pack
M54HC03D	9201/114/03F or 04F	ESCC flight	Specify ESCC variant number in PO	DIL-14	Gold or solder dip	920111403F or 04F	2.20	-	Strip pack
M54HC04K	9401/033/01F or 02F	ESCC flight	Specify ESCC variant number in PO	Flat-14	Gold or solder dip	940103301F or 02F	0.70	Y	Strip pack
M54HC04D	9401/033/03F or 04F	ESCC flight	Specify ESCC variant number in PO	DIL-14	Gold or solder dip	940103303F or 04F	2.20	-	Strip pack
M54HC08K	9201/106/01F or 02F	ESCC flight	Specify ESCC variant number in PO	Flat-14	Gold or solder dip	920110601F or 02F	0.70	Y	Strip pack
M54HC08D	9201/106/03F or 04F	ESCC flight	Specify ESCC variant number in PO	DIL-14	Gold or solder dip	920110603F or 04F	2.20	-	Strip pack
M54HC10K	9201/107/01F or 02F	ESCC flight	Specify ESCC variant number in PO	Flat-14	Gold or solder dip	920110701F or 02F	0.70	Y	Strip pack
M54HC10D	9201/107/03F or 04F	ESCC flight	Specify ESCC variant number in PO	DIL-14	Gold or solder dip	920110703F or 04F	2.20	-	Strip pack
M54HC11K	9201/117/01F or 02F	ESCC flight	Specify ESCC variant number in PO	Flat-14	Gold or solder dip	920111701F or 02F	0.70	Y	Strip pack
M54HC11D	9201/117/03F or 04F	ESCC flight	Specify ESCC variant number in PO	DIL-14	Gold or solder dip	920111703F or 04F	2.20	-	Strip pack
M54HC14K	9409/007/01F or 02F	ESCC flight	Specify ESCC variant number in PO	Flat-14	Gold or solder dip	940900701F or 02F	0.70	Y	Strip pack
M54HC14D	9409/007/03F or 04F	ESCC flight	Specify ESCC variant number in PO	DIL-14	Gold or solder dip	940900703F or 04F	2.20	-	Strip pack
M54HC20K	9201/118/01F or 02F	ESCC flight	Specify ESCC variant number in PO	Flat-14	Gold or solder dip	920111801F or 02F	0.70	Y	Strip pack
M54HC20D	9201/118/03F or 04F	ESCC flight	Specify ESCC variant number in PO	DIL-14	Gold or solder dip	920111803F or 04F	2.20	-	Strip pack
M54HC21K	9201/108/01F or 02F	ESCC flight	Specify ESCC variant number in PO	Flat-14	Gold or solder dip	920110801F or 02F	0.70	Y	Strip pack
M54HC21D	9201/108/03F or 04F	ESCC flight	Specify ESCC variant number in PO	DIL-14	Gold or solder dip	920110803F or 04F	2.20	-	Strip pack
M54HC27K	9201/109/01F or 02F	ESCC flight	Specify ESCC variant number in PO	Flat-14	Gold or solder dip	920110901F or 02F	0.70	Y	Strip pack
M54HC27D	9201/109/03F or 04F	ESCC flight	Specify ESCC variant number in PO	DIL-14	Gold or solder dip	920110903F or 04F	2.20	-	Strip pack



Table 15. Ordering information⁽¹⁾ (continued)

Order codes	ESCC detailed specification	Quality level	Comment	Package	Lead finish	Marking ⁽²⁾	Mass (g)	EPPL	Packing
M54HC30K	9201/110/01F or 02F	ESCC flight	Specify ESCC variant number in PO	Flat-14	Gold or solder dip	920111001F or 02F	0.70	-	Strip pack
M54HC30D	9201/110/03F or 04F	ESCC flight	Specify ESCC variant number in PO	DIL-14	Gold or solder dip	920111003F or 04F	2.20	-	Strip pack
M54HC32K	9201/111/01F or 02F	ESCC flight	Specify ESCC variant number in PO	Flat-14	Gold or solder dip	920111101F or 02F	0.70	Y	Strip pack
M54HC32D	9201/111/03F or 04F	ESCC flight	Specify ESCC variant number in PO	DIL-14	Gold or solder dip	920111103F or 04F	2.20	-	Strip pack
M54HC73K	9203/071/01F or 02F	ESCC flight	Specify ESCC variant number in PO	Flat-14	Gold or solder dip	920307101F or 02F	0.70	-	Strip pack
M54HC73D	9203/071/03F or 04F	ESCC flight	Specify ESCC variant number in PO	DIL-14	Gold or solder dip	920307103F or 04F	2.20	-	Strip pack
M54HC74K	9203/050/01F or 02F	ESCC flight	Specify ESCC variant number in PO	Flat-14	Gold or solder dip	920305001F or 02F	0.70	Y	Strip pack
M54HC74D	9203/050/03F or 04F	ESCC flight	Specify ESCC variant number in PO	DIL-14	Gold or solder dip	920305003F or 04F	2.20	-	Strip pack
M54HCT74K	9203/070/01F or 02F	ESCC flight	Specify ESCC variant number in PO	Flat-14	Gold or solder dip	920307001F or 02F	0.70	Y	Strip pack
M54HCT74D	9203/070/03F or 04F	ESCC flight	Specify ESCC variant number in PO	DIL-14	Gold or solder dip	920307003F or 04F	2.20	-	Strip pack
M54HC75K	9203/065/01F or 02F	ESCC flight	Specify ESCC variant number in PO	Flat-16	Gold or solder dip	920306501F or 02F	0.70	-	Strip pack
M54HC75D	9203/065/10F or 11F	ESCC flight	Specify ESCC variant number in PO	DIL-16	Gold or solder dip	920306510F or 11F	2.20	-	Strip pack
M54HC85K	9209/004/01F or 02F	ESCC flight	Specify ESCC variant number in PO	Flat-16	Gold or solder dip	920900401F or 02F	0.70	Y	Strip pack
M54HC85D	9209/004/10F or 11F	ESCC flight	Specify ESCC variant number in PO	DIL-16	Gold or solder dip	920900410F or 11F	2.20	-	Strip pack
M54HC86K	9201/119/01F or 02F	ESCC flight	Specify ESCC variant number in PO	Flat-14	Gold or solder dip	920111901F or 02F	0.70	Y	Strip pack
M54HC86D	9201/119/03F or 04F	ESCC flight	Specify ESCC variant number in PO	DIL-14	Gold or solder dip	920111903F or 04F	2.20	-	Strip pack
M54HC109K	9306/048/01F or 02F	ESCC flight	Specify ESCC variant number in PO	Flat-16	Gold or solder dip	930604801F or 02F	0.70	Y	Strip pack
M54HC109D	9306/048/10F or 11F	ESCC flight	Specify ESCC variant number in PO	DIL-16	Gold or solder dip	930604810F or 11F	2.20	-	Strip pack
M54HC123K	9207/006/01F or 02F	ESCC flight	Specify ESCC variant number in PO	Flat-16	Gold or solder dip	920700601F or 02F	0.70	-	Strip pack
M54HC123D	9207/006/10F or 11F	ESCC flight	Specify ESCC variant number in PO	DIL-16	Gold or solder dip	920700610F or 11F	2.20	-	Strip pack
M54HC125K	9401/039/01F or 02F	ESCC flight	Specify ESCC variant number in PO	Flat-14	Gold or solder dip	940103901F or 02F	0.70	Y	Strip pack
M54HC132K	9201/120/01F or 02F	ESCC flight	Specify ESCC variant number in PO	Flat-14	Gold or solder dip	920112001F or 02F	0.70	Y	Strip pack
M54HC132D	9201/120/03F or 04F	ESCC flight	Specify ESCC variant number in PO	DIL-14	Gold or solder dip	920112003F or 04F	2.20	-	Strip pack
M54HC137K	9205/013/01F or 02F	ESCC flight	Specify ESCC variant number in PO	Flat-16	Gold or solder dip	920501301F or 02F	0.70	-	Strip pack
M54HC137D	9205/013/10F or 11F	ESCC flight	Specify ESCC variant number in PO	DIL-16	Gold or solder dip	920501310F or 11F	2.20	-	Strip pack



Table 15. Ordering information⁽¹⁾ (continued)

Order codes	ESCC detailed specification	Quality level	Comment	Package	Lead finish	Marking ⁽²⁾	Mass (g)	EPPL	Packing
M54HC138K	9408/046/01F or 02F	ESCC flight	Specify ESCC variant number in PO	Flat-16	Gold or solder dip	940804601F or 02F	0.70	Y	Strip pack
M54HC138D	9408/046/10F or 11F	ESCC flight	Specify ESCC variant number in PO	DIL-16	Gold or solder dip	940804610F or 11F	2.20	-	Strip pack
M54HC139K	9205/017/01F or 02F	ESCC flight	Specify ESCC variant number in PO	Flat-16	Gold or solder dip	920501701F or 02F	0.70	Y	Strip pack
M54HC139D	9205/017/10F or 11F	ESCC flight	Specify ESCC variant number in PO	DIL-16	Gold or solder dip	920501710F or 11F	2.20	-	Strip pack
M54HC148K	9410/017/01F or 02F	ESCC flight	Specify ESCC variant number in PO	Flat-16	Gold or solder dip	9410-01701F or 02F	0.70	-	Strip pack
M54HC148D	9410/017/10F or 11F	ESCC flight	Specify ESCC variant number in PO	DIL-16	Gold or solder dip	9410-01710F or 11F	2.20	-	Strip pack
M54HC151K	9408/054/01F or 02F	ESCC flight	Specify ESCC variant number in PO	Flat-16	Gold or solder dip	940805401F or 02F	0.70	Y	Strip pack
M54HC151D	9408/054/10F or 11F	ESCC flight	Specify ESCC variant number in PO	DIL-16	Gold or solder dip	940805410F or 11F	2.20	-	Strip pack
M54HC153K	9408/038/01F or 02F	ESCC flight	Specify ESCC variant number in PO	Flat-16	Gold or solder dip	940803801F or 02F	0.70	-	Strip pack
M54HC153D	9408/038/10F or 11F	ESCC flight	Specify ESCC variant number in PO	DIL-16	Gold or solder dip	940803810F or 11F	2.20	-	Strip pack
M54HC154K	9205/023/01F or 02F	ESCC flight	Specify ESCC variant number in PO	Flat-24	Gold or solder dip	920502301F or 02F	1.70	Y	Strip pack
M54HC154D	9205/023/03F or 04F	ESCC flight	Specify ESCC variant number in PO	DIL-24	Gold or solder dip	920502303F or 04F	5.20	-	Strip pack
M54HC157K	9408/057/01F or 02F	ESCC flight	Specify ESCC variant number in PO	Flat-16	Gold or solder dip	940805701F or 02F	0.70	Y	Strip pack
M54HC157D	9408/057/10F or 11F	ESCC flight	Specify ESCC variant number in PO	DIL-16	Gold or solder dip	940805710F or 11F	2.20	-	Strip pack
M54HC158K	9408/059/01F or 02F	ESCC flight	Specify ESCC variant number in PO	Flat-16	Gold or solder dip	940805901F or 02F	0.70	Y	Strip pack
M54HC158D	9408/059/10F or 11F	ESCC flight	Specify ESCC variant number in PO	DIL-16	Gold or solder dip	940805910F or 11F	2.20	-	Strip pack
M54HC160D	9204/062/10F or 11F	ESCC flight	Specify ESCC variant number in PO	DIL-16	Gold or solder dip	920406210F or 11F	2.20	-	Strip pack
M54HC161K	9204/059/01F or 02F	ESCC flight	Specify ESCC variant number in PO	Flat-16	Gold or solder dip	920405901F or 02F	0.70	Y	Strip pack
M54HC161D	9204/059/10F or 11F	ESCC flight	Specify ESCC variant number in PO	DIL-16	Gold or solder dip	920405910F or 11F	2.20	-	Strip pack
M54HC164K	9306/041/01F or 02F	ESCC flight	Specify ESCC variant number in PO	Flat-14	Gold or solder dip	930604101F or 02F	0.70	Y	Strip pack
M54HC164D	9306/041/03F or 04F	ESCC flight	Specify ESCC variant number in PO	DIL-14	Gold or solder dip	930604103F or 04F	2.20	-	Strip pack
M54HC165K	9306/042/01F or 02F	ESCC flight	Specify ESCC variant number in PO	Flat-16	Gold or solder dip	930604201F or 02F	0.70	Y	Strip pack
M54HC165D	9306/042/10F or 11F	ESCC flight	Specify ESCC variant number in PO	DIL-16	Gold or solder dip	930604210F or 11F	2.20	-	Strip pack
M54HC166K	9306/043/01F or 02F	ESCC flight	Specify ESCC variant number in PO	Flat-16	Gold or solder dip	930604301F or 02F	0.70	Y	Strip pack
M54HC166D	9306/043/10F or 11F	ESCC flight	Specify ESCC variant number in PO	DIL-16	Gold or solder dip	930604310F or 11F	2.20	-	Strip pack



Table 15. Ordering information⁽¹⁾ (continued)

Order codes	ESCC detailed specification	Quality level	Comment	Package	Lead finish	Marking ⁽²⁾	Mass (g)	EPPL	Packing
M54HC174K	9306/052/01F or 02F	ESCC flight	Specify ESCC variant number in PO	Flat-16	Gold or solder dip	930605201F or 02F	0.70	Y	Strip pack
M54HC174D	9306/052/10F or 11F	ESCC flight	Specify ESCC variant number in PO	DIL-16	Gold or solder dip	930605210F or 11F	2.20	-	Strip pack
M54HC175K	9203/052/01F or 02F	ESCC flight	Specify ESCC variant number in PO	Flat-16	Gold or solder dip	920305201F or 02F	0.70	Y	Strip pack
M54HC175D	9203/052/10F or 11F	ESCC flight	Specify ESCC variant number in PO	DIL-16	Gold or solder dip	920305210F or 11F	2.20	-	Strip pack
M54HC191K	9204/066/01F or 02F	ESCC flight	Specify ESCC variant number in PO	Flat-16	Gold or solder dip	920406601F or 02F	0.70	Y	Strip pack
M54HC191D	9204/066/10F or 11F	ESCC flight	Specify ESCC variant number in PO	DIL-16	Gold or solder dip	920406610F or 11F	2.20	-	Strip pack
M54HC193K	9204/065/01F or 02F	ESCC flight	Specify ESCC variant number in PO	Flat-16	Gold or solder dip	920406501F or 02F	0.70	Y	Strip pack
M54HC193D	9204/065/10F or 11F	ESCC flight	Specify ESCC variant number in PO	DIL-16	Gold or solder dip	920406510F or 11F	2.20	-	Strip pack
M54HC194K	9306/047/01F or 02F	ESCC flight	Specify ESCC variant number in PO	Flat-16	Gold or solder dip	930604701F or 02F	0.70	-	Strip pack
M54HC194D	9306/047/10F or 11F	ESCC flight	Specify ESCC variant number in PO	DIL-16	Gold or solder dip	930604710F or 11F	2.20	-	Strip pack
M54HC237K	9205/021/01F or 02F	ESCC flight	Specify ESCC variant number in PO	Flat-16	Gold or solder dip	920502101F or 02F	0.70	Y	Strip pack
M54HC237D	9205/021/10F or 11F	ESCC flight	Specify ESCC variant number in PO	DIL-16	Gold or solder dip	920502110F or 11F	2.20	-	Strip pack
M54HC240K	9401/034/01F or 02F	ESCC flight	Specify ESCC variant number in PO	Flat-20	Gold or solder dip	940103401F or 02F	0.90	Y	Strip pack
M54HC240D	9401/034/03F or 04F	ESCC flight	Specify ESCC variant number in PO	DIL-20	Gold or solder dip	940103403F or 04F	3.20	-	Strip pack
M54HCT240K	9401/045/01F or 02F	ESCC flight	Specify ESCC variant number in PO	Flat-20	Gold or solder dip	940104501F or 02F	0.90	Y	Strip pack
M54HCT240D	9401/045/03F or 04F	ESCC flight	Specify ESCC variant number in PO	DIL-20	Gold or solder dip	940104503F or 04F	3.20	-	Strip pack
M54HC244K	9401/048/01F or 02F	ESCC flight	Specify ESCC variant number in PO	Flat-20	Gold or solder dip	940104801F or 02F	0.90	Y	Strip pack
M54HC244D	9401/048/03F or 04F	ESCC flight	Specify ESCC variant number in PO	DIL-20	Gold or solder dip	940104803F or 04F	3.20	-	Strip pack
M54HCT244K	9402/009/01F or 02F	ESCC flight	Specify ESCC variant number in PO	Flat-20	Gold or solder dip	940200901F or 02F	0.90	Y	Strip pack
M54HCT244D	9402/009/03F or 04F	ESCC flight	Specify ESCC variant number in PO	DIL-20	Gold or solder dip	9402-00903F or 04F	3.20	-	Strip pack
M54HC245K	9405/013/01F or 02F	ESCC flight	Specify ESCC variant number in PO	Flat-20	Gold or solder dip	940501301F or 02F	0.90	Y	Strip pack
M54HC245D	9405/013/03F or 04F	ESCC flight	Specify ESCC variant number in PO	DIL-20	Gold or solder dip	9405-01303F or 04F	3.20	-	Strip pack
M54HCT245K	9405/014/01F or 02F	ESCC flight	Specify ESCC variant number in PO	Flat-20	Gold or solder dip	940501401F or 02F	0.90	Y	Strip pack
M54HCT245D	9405/014/03F or 04F	ESCC flight	Specify ESCC variant number in PO	DIL-20	Gold or solder dip	9405-01403F or 04F	3.20	-	Strip pack
M54HC251K	9408/048/01F or 02F	ESCC flight	Specify ESCC variant number in PO	Flat-16	Gold or solder dip	940804801F or 02F	0.70	-	Strip pack



Table 15. Ordering information⁽¹⁾ (continued)

Order codes	ESCC detailed specification	Quality level	Comment	Package	Lead finish	Marking ⁽²⁾	Mass (g)	EPPL	Packing
M54HC251D	9408/048/10F or 11F	ESCC flight	Specify ESCC variant number in PO	DIL-16	Gold or solder dip	940804810F or 11F	2.20	-	Strip pack
M54HC257K	9408/047/01F or 02F	ESCC flight	Specify ESCC variant number in PO	Flat-16	Gold or solder dip	940804701F or 02F	0.70	Y	Strip pack
M54HC259K	9203/073/01F or 02F	ESCC flight	Specify ESCC variant number in PO	Flat-16	Gold or solder dip	920307301F or 02F	0.70	-	Strip pack
M54HC259D	9203/073/10F or 11F	ESCC flight	Specify ESCC variant number in PO	DIL-16	Gold or solder dip	920307310F or 11F	2.20	-	Strip pack
M54HC273K	9203/053/01F or 02F	ESCC flight	Specify ESCC variant number in PO	Flat-20	Gold or solder dip	920305301F or 02F	0.90	Y	Strip pack
M54HC273D	9203/053/03F or 04F	ESCC flight	Specify ESCC variant number in PO	DIL-20	Gold or solder dip	920305303F or 04F	3.20	-	Strip pack
M54HC283K	9202/075/01F or 02F	ESCC flight	Specify ESCC variant number in PO	Flat-16	Gold or solder dip	920207501F or 02F	0.70	Y	Strip pack
M54HC283D	9202/075/10F or 11F	ESCC flight	Specify ESCC variant number in PO	DIL-16	Gold or solder dip	920207510F or 11F	2.20	-	Strip pack
M54HC367K	9401/044/01F or 02F	ESCC flight	Specify ESCC variant number in PO	Flat-16	Gold or solder dip	940104401F or 02F	0.70	-	Strip pack
M54HC367D	9401/044/10F or 11F	ESCC flight	Specify ESCC variant number in PO	DIL-16	Gold or solder dip	940104410F or 11F	2.20	-	Strip pack
M54HC373K	9203/059/01F or 02F	ESCC flight	Specify ESCC variant number in PO	Flat-20	Gold or solder dip	920305901F or 02F	0.90	Y	Strip pack
M54HC373D	9203/059/03F or 04F	ESCC flight	Specify ESCC variant number in PO	DIL-20	Gold or solder dip	920305903F or 04F	3.20	-	Strip pack
M54HCT373K	9203/064/01F or 02F	ESCC flight	Specify ESCC variant number in PO	Flat-20	Gold or solder dip	920306401F or 02F	0.90	Y	Strip pack
M54HCT373D	9203/064/03F or 04F	ESCC flight	Specify ESCC variant number in PO	DIL-20	Gold or solder dip	920306403F or 04F	3.20	-	Strip pack
M54HC374K	9203/060/01F or 02F	ESCC flight	Specify ESCC variant number in PO	Flat-20	Gold or solder dip	920306001F or 02F	0.90	Y	Strip pack
M54HC374D	9203/060/03F or 04F	ESCC flight	Specify ESCC variant number in PO	DIL-20	Gold or solder dip	920306003F or 04F	3.20	-	Strip pack
M54HC393K	9204/074/01F or 02F	ESCC flight	Specify ESCC variant number in PO	Flat-14	Gold or solder dip	920407401F or 02F	0.70	-	Strip pack
M54HC393D	9204/074/03F or 04F	ESCC flight	Specify ESCC variant number in PO	DIL-14	Gold or solder dip	920407403F or 04F	2.20	-	Strip pack
M54HC540K	9401/049/01F or 02F	ESCC flight	Specify ESCC variant number in PO	Flat-20	Gold or solder dip	940104901F or 02F	0.90	Y	Strip pack
M54HC540D	9401/049/03F or 04F	ESCC flight	Specify ESCC variant number in PO	DIL-20	Gold or solder dip	940104903F or 04F	3.20	-	Strip pack
M54HC541K	9401/047/01F or 02F	ESCC flight	Specify ESCC variant number in PO	Flat-20	Gold or solder dip	940104701F or 02F	0.90	Y	Strip pack
M54HC541D	9401/047/03F or 04F	ESCC flight	Specify ESCC variant number in PO	DIL-20	Gold or solder dip	940104703F or 04F	3.20	-	Strip pack
M54HC573K	9202/072/01F or 02F	ESCC flight	Specify ESCC variant number in PO	Flat-20	Gold or solder dip	920207201F or 02F	0.90	Y	Strip pack
M54HC573D	9202/072/03F or 04F	ESCC flight	Specify ESCC variant number in PO	DIL-20	Gold or solder dip	920207203F or 04F	3.20	-	Strip pack
M54HC574K	9203/054/01F or 02F	ESCC flight	Specify ESCC variant number in PO	Flat-20	Gold or solder dip	920305401F or 02F	0.90	Y	Strip pack



Table 15. Ordering information⁽¹⁾ (continued)

Order codes	ESCC detailed specification	Quality level	Comment	Package	Lead finish	Marking ⁽²⁾	Mass (g)	EPPL	Packing
M54HC574D	9203/054/03F or 04F	ESCC flight	Specify ESCC variant number in PO	DIL-20	Gold or solder dip	920305403F or 04F	3.20	-	Strip pack
M54HC590K	9204/071/01F or 02F	ESCC flight	Specify ESCC variant number in PO	Flat-16	Gold or solder dip	920407101F or 02F	0.70	Y	Strip pack
M54HC590D	9204/071/10F or 11F	ESCC flight	Specify ESCC variant number in PO	DIL-16	Gold or solder dip	920407110F or 11F	2.20	-	Strip pack
M54HC595K	9306/051/01F or 02F	ESCC flight	Specify ESCC variant number in PO	Flat-16	Gold or solder dip	930605101F or 02F	0.70	Y	Strip pack
M54HC595D	9306/051/10F or 11F	ESCC flight	Specify ESCC variant number in PO	DIL-16	Gold or solder dip	930605110F or 11F	2.20	-	Strip pack
M54HC597K	9306/054/01F or 02F	ESCC flight	Specify ESCC variant number in PO	Flat-16	Gold or solder dip	930605401F or 02F	0.70	Y	Strip pack
M54HC597D	9306/054/10F or 11F	ESCC flight	Specify ESCC variant number in PO	DIL-16	Gold or solder dip	930605410F or 11F	2.20	-	Strip pack
M54HC688K	9209/005/01F or 02F	ESCC flight	Specify ESCC variant number in PO	Flat-20	Gold or solder dip	920900501F or 02F	0.90	Y	Strip pack
M54HC688D	9209/005/03F or 04F	ESCC flight	Specify ESCC variant number in PO	DIL-20	Gold or solder dip	920900503F or 04F	3.20	-	Strip pack
M54HC4020K	9204/070/01F or 02F	ESCC flight	Specify ESCC variant number in PO	Flat-16	Gold or solder dip	920407001F or 02F	0.70	-	Strip pack
M54HC4020D	9204/070/10F or 11F	ESCC flight	Specify ESCC variant number in PO	DIL-16	Gold or solder dip	920407010F or 11F	2.20	-	Strip pack
M54HC4040K	9204/069/01F or 02F	ESCC flight	Specify ESCC variant number in PO	Flat-16	Gold or solder dip	920406901F or 02F	0.70	Y	Strip pack
M54HC4040D	9204/069/10F or 11F	ESCC flight	Specify ESCC variant number in PO	DIL-16	Gold or solder dip	920406910F or 11F	2.20	-	Strip pack
M54HC4049K	9401/037/01F or 02F	ESCC flight	Specify ESCC variant number in PO	Flat-16	Gold or solder dip	940103701F or 02F	0.70	Y	Strip pack
M54HC4049D	9401/037/10F or 11F	ESCC flight	Specify ESCC variant number in PO	DIL-16	Gold or solder dip	940103710F or 11F	2.20	-	Strip pack
M54HC4050K	9401/038/01F or 02F	ESCC flight	Specify ESCC variant number in PO	Flat-16	Gold or solder dip	940103801F or 02F	0.70	Y	Strip pack
M54HC4050D	9401/038/10F or 11F	ESCC flight	Specify ESCC variant number in PO	DIL-16	Gold or solder dip	940103810F or 11F	2.20	-	Strip pack
M54HC4051K	9408/064/01F or 02F	ESCC flight	Specify ESCC variant number in PO	Flat-16	Gold or solder dip	940806401F or 02F	0.70	-	Strip pack
M54HC4051D	9408/064/10F or 11F	ESCC flight	Specify ESCC variant number in PO	DIL-16	Gold or solder dip	940806410F or 11F	2.20	-	Strip pack
M54HC4053K	9408/065/01F or 02F	ESCC flight	Specify ESCC variant number in PO	Flat-16	Gold or solder dip	940806501F or 02F	0.70	-	Strip pack
M54HC4053D	9408/065/10F or 11F	ESCC flight	Specify ESCC variant number in PO	DIL-16	Gold or solder dip	940806510F or 11F	2.20	-	Strip pack
M54HC4060K	9204/076/01F or 02F	ESCC flight	Specify ESCC variant number in PO	Flat-16	Gold or solder dip	920407601F or 02F	0.70	-	Strip pack
M54HC4060D	9204/076/10F or 11F	ESCC flight	Specify ESCC variant number in PO	DIL-16	Gold or solder dip	920407610F or 11F	2.20	-	Strip pack
M54HC4066K	9408/052/01F or 02F	ESCC flight	Specify ESCC variant number in PO	Flat-14	Gold or solder dip	940805201F or 02F	0.70	-	Strip pack
M54HC4066D	9408/052/03F or 04F	ESCC flight	Specify ESCC variant number in PO	DIL-14	Gold or solder dip	940805203F or 04F	2.20	-	Strip pack



Table 15. Ordering information⁽¹⁾ (continued)

Order codes	ESCC detailed specification	Quality level	Comment	Package	Lead finish	Marking ⁽²⁾	Mass (g)	EPPL	Packing
M54HC4078K	9201/123/01F or 02F	ESCC flight	Specify ESCC variant number in PO	Flat-14	Gold or solder dip	920112301F or 02F	0.70	-	Strip pack
M54HC4078D	9201/123/03F or 04F	ESCC flight	Specify ESCC variant number in PO	DIL-14	Gold or solder dip	920112303F or 04F	2.20	-	Strip pack
M54HC4094K	9306/050/01F or 02F	ESCC flight	Specify ESCC variant number in PO	Flat-16	Gold or solder dip	930605001F or 02F	0.70	-	Strip pack
M54HC4094D	9306/050/10F or 11F	ESCC flight	Specify ESCC variant number in PO	DIL-16	Gold or solder dip	930605010F or 11F	2.20	-	Strip pack
M54HC4514K	9205/019/01F or 02F	ESCC flight	Specify ESCC variant number in PO	Flat-24	Gold or solder dip	920501901F or 02F	1.70	-	Strip pack
M54HC4514D	9205/019/03F or 04F	ESCC flight	Specify ESCC variant number in PO	DIL-24	Gold or solder dip	920501903F or 04F	5.20	-	Strip pack

1. Contact ST sales office for information about the specific conditions for other 54HC or 54HCT part numbers and for products in die form.

2. Specific marking only. Complete marking includes the following:

- ST logo
- ESA logo
- Date code (date the package was sealed) in YYWWA (year, week number, and week index)
- ESCC part number (as mentioned in [Table 15](#))
- Country of origin (FR = France)
- Part serial number within the assembly lot.

7 Other information

7.1 Date code

Date code is structured as described below:

- EM xyywwz
- ESCC flight yywwz

where:

- x (EM only): 3, assembly location Rennes (France)
- yy: last two digits year
- ww: week digits
- z: lot index in the week

7.2 Documentation

In [Table 16](#) is a summary of the documentation provided with each type of products.

Table 16. Documentation provided for each type of product

Quality level	Documentation
Engineering model	-
ESCC flight	Certificate of conformance Radiation verification test report

8 Revision history

Table 17. Document revision history

Date	Revision	Changes
14-Apr-2010	1	First release
02-Aug-2011	2	Added <i>Note: on page 14, 1. on page 14, 1. on page 15, 1. on page 16, 1. on page 19, 1. on page 20</i> and in the "Pin connections" diagram on the coverpage
29-May-2013	3	<p>Updated Flat-24 package in figure on page 1.</p> <p>Updated <i>Section 2: Input and output equivalent circuit diagram</i> (updated titles - added "output", updated <i>Figure 1</i>, added note 1. below <i>Figure 1</i>).</p> <p>Updated <i>Table 1</i> (removed M54HCU04, M54HC163, M54HC238, M54HC241, M54HC253, M54HC365, M54HCT374, M54HC390, M54HC4002, M54HC4072, and M54HC4075 device).</p> <p>Updated note 1. below <i>Table 1</i> (removed "QML-Q versions").</p> <p>Added note 2. below <i>Table 3</i>, renumbered notes below <i>Table 3</i>.</p> <p>Added t_r, t_f symbols, parameters, values and units to <i>Table 4</i>.</p> <p>Updated <i>Section 5: Package information</i> (added <i>Figure 6</i> and <i>Figure 7</i>, <i>Table 11</i> and <i>Table 12</i>, reversed order of <i>Figure 2</i> to <i>Figure 5</i>, <i>Figure 8</i> and <i>Figure 9</i>, <i>Table 8</i> to <i>Table 10</i>, <i>Table 13</i> and <i>Table 14</i>, corrected typ. dimension for symbol "L" in <i>Table 9</i>).</p> <p>Updated <i>Table 15</i> (removed M54HCU04K/D, M54HC163K/D, M54HC238K/D, M54HC241K/D, M54HC253K/D, M54HC365K/D, M54HCT374K/D, M54HC390K/D, M54HC4002K/D, M54HC4072K/D, and M54HC4075K/D device).</p> <p>Added note 2. below <i>Table 15</i>, updated note 1. (removed "QML-Q versions"), renumbered notes below <i>Table 15</i>.</p> <p>Added <i>Section 7: Other information</i>.</p> <p>Minor corrections throughout document.</p>

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